

Issuer & Securities

Issuer/ Manager

HAI LECK HOLDINGS LIMITED

Security

HAI LECK HOLDINGS LIMITED - SG1CC4000004 - BLH

Announcement Details

Announcement Title

Bonus Issue/ Capitalisation Issue

Date & Time of Broadcast

22-Jun-2021 18:23:11

Status

Replacement

Corporate Action Reference

SG210514BONUOUDR

Submitted By (Co./ Ind. Name)

Siau Kuei Lian

Designation

Company Secretary

Financial Year End

30/06/2021

Foreign Shareholder Eligibility

Yes

Foreign Shareholder Applicability

All

Event Narrative

Narrative Type	Narrative Text
Additional Text	Please refer to the attachment.
Additional Text	Please refer to the attachment.
Additional Text	Please refer to the attached Notice of Record Date.
Additional Text	Please refer to the attached Listing and Quotation of Bonus Shares.

Event Dates

Record Date and Time

15/06/2021 17:00:00

Ex Date

14/06/2021

Disbursement Details

New Security Details

New Security ISIN

SG1CC4000004

REPL::BONUS ISSUE/ CAPITALISATION ISSUE::MANDATORY

Security Not Found?

No

Security Credit Date

24/06/2021

Distribution Ratio (Additional: Old)

1:10

Attachments

 [Approval in Principle for Listing and Quotation.pdf](#)

 [Proposed Bonus Issue.pdf](#)

 [Notice of Record Date.pdf](#)

 [Listing and Quotation of Bonus Shares.pdf](#)

Total size =553K MB

Related Announcements

Related Announcements

[07/06/2021 17:41:38](#)

[31/05/2021 07:38:23](#)

[14/05/2021 17:27:51](#)

HAI LECK HOLDINGS LIMITED
(Incorporated in the Republic of Singapore)
(Company Registration Number: 199804461D)

PROPOSED BONUS ISSUE – LISTING AND QUOTATION OF BONUS SHARES

The board of directors (the “**Board**”) of Hai Leck Holdings Limited (the “**Company**”) refers to the Company’s announcements on 14 May 2021, 31 May 2021, and 7 June 2021 in relation to the Proposed Bonus Issue (the “**Announcements**”). Unless otherwise defined herein or the context otherwise requires, all capitalised terms used in this announcement shall bear the meanings ascribed to them in the Announcements.

Further to the Announcements, the Board is pleased to inform that 20,599,248 Bonus Shares have been allotted and issued on 22 June 2021. Following the allotment and issue of the Bonus Shares, the total number of issued Shares of the Company has increased from 205,993,947 to 226,593,195 Shares.

The Bonus Shares are expected to be listed and quoted on the SGX-ST with effect from 9.00 a.m. on 24 June 2021.

BY ORDER OF THE BOARD

Cheng Buck Poh
Executive Chairman and Chief Executive Officer

22 June 2021